# SMD Type 5000 W

# TKS

#### **■** Features

- 1. High reliability application and automotive grade AEC Q101 qualified
- 2. 5000W peak pulse power capability with a 10/1000 µs waveform, repetitive rate (duty cycle): 0.01%
- 3. Low leakage current
- 4. Excellent clamping capability
- 5. RoHS compliant
- 6. Very fast response time
- 7. ESD protection of data lines in accordance with IEC 61000-4-2,30kV(Air),30kV(Contact)



#### ■ Recommended Applications

- 1. Telecommunication
- 2. Computer
- 3. Industrial device
- 4. Consumer electronic device
- 5. Automotive

#### ■ Mechanical Data

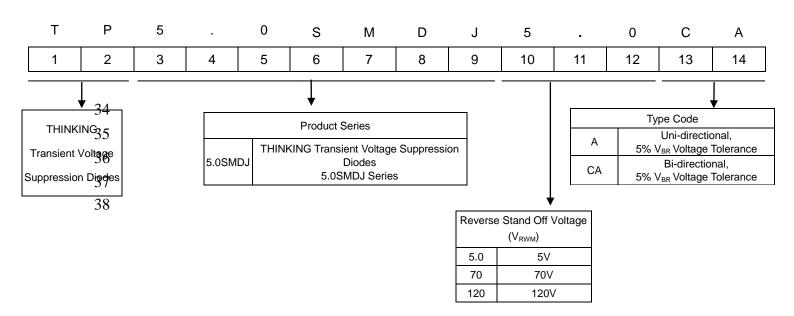
1. Case: DO-214AB (SMC), molded plastic meets

2. Epoxy: UL 94V-0 rate flame retardant

3. Terminal: Solderable per MIL-STD-750, Method 2026

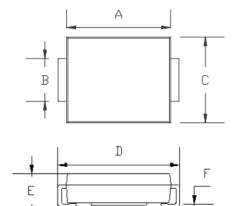
4. Polarity: Color band denotes cathode end

#### ■ Part Number Code

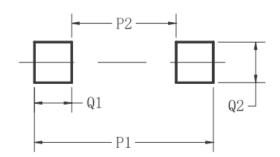


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#### **Structures and Dimensions**







SMC / DO-214AB				
Dimensions	Millimeters			
	Min	Max		
Α	6.60	7.15		
В	2.75	3.27		
С	5.55	6.22		
D	7.75	8.13		
ш	1.98	2.80		
F	0.15	0.31		
G	0.75	1.52		
Н	0.00	0.30		

SMC / DO-214AB		
Dimensions Millimeters		
P1	9.90	
P2	3.84	
Q1	3.03	
Q2	3.82	

### Maximum Rating (T<sub>A</sub>=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak pulse power dissipation at T <sub>A</sub> =25 °C by 10/1000µs waveform (Note1、2)		С	W
Peak forward surge current, 8.3ms single half sine wave on rated load (Note 3)		300	Α
Power dissipation on infinite heatsink at T <sub>L</sub> =75°C		6.5	W
Maximum instantaneous forward voltage at 100A for unidirectional only	VF	3.5	V
Typical thermal resistance junction to ambient	Rеја	75	°C/W
Typical thermal resistance junction to lead	Røjl	15	°C/W
Operating junction and storage temperature range		-65~+150	°C

Notes: (1) Non-repetitive current pulse, per Fig. 3 and derated above TA=25℃ per Fig. 2

- (2) Mounted on copper pad area of 0.31" x 0.31" (8.0 x 8.0mm) to each terminal
- (3) Measured on 8.3ms single half sine wave or equivalent square wave for unidirectional device only, duty cycle=4 per minute maximum



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#### ■ Electrical Characteristics (T<sub>A</sub>=25°C unless otherwise noted)

Part No. (Uni)	Part No. (Bi)	Reverse Stand off Voltage  VRWM (V)	Brea Vol	akage tage @ IT Max( V )	Test Current IT( mA )	Maximum Clamping Voltage VC @ Ipp	Maximum Peak Pulse Current	Maximum Reverse Leakage IR @VRWM		king ode Bi
TP5.0SMDJ11A	TP5.0SMDJ11CA	11	12.2	13.5	1	18.2	274.73	800	5PDX	5BDX
TP5.0SMDJ12A	TP5.0SMDJ12CA	12	13.3	14.7	1	19.9	251.26	800	5PDZ	5BDZ
TP5.0SMDJ13A	TP5.0SMDJ13CA	13	14.4	15.9	1	21.5	232.56	500	5PEE	5BEE
TP5.0SMDJ14A	TP5.0SMDJ14CA	14	15.6	17.2	1	23.2	215.52	200	5PEG	5BEG
TP5.0SMDJ15A	TP5.0SMDJ15CA	15	16.7	18.5	1	24.4	204.92	100	5PEK	5BEK
TP5.0SMDJ16A	TP5.0SMDJ16CA	16	17.8	19.7	1	26	192.31	50	5PEM	5BEM
TP5.0SMDJ17A	TP5.0SMDJ17CA	17	18.9	20.9	1	27.6	181.16	20	5PEP	5BEP
TP5.0SMDJ18A	TP5.0SMDJ18CA	18	20	22.1	1	29.2	171.23	10	5PER	5BER
TP5.0SMDJ19A	TP5.0SMDJ19CA	19	21.1	23.3	1	30.8	162.34	10	5PET	5BET
TP5.0SMDJ20A	TP5.0SMDJ20CA	20	22.2	24.5	1	32.4	154.32	5	5PEV	5BEV
TP5.0SMDJ22A	TP5.0SMDJ22CA	22	24.4	26.9	1	35.5	140.85	5	5PEX	5BEX
TP5.0SMDJ24A	TP5.0SMDJ24CA	24	26.7	29.5	1	38.9	128.53	2	5PEZ	5BEZ
TP5.0SMDJ26A	TP5.0SMDJ26CA	26	28.9	31.9	1	42.1	118.76	2	5PFE	5BFE
TP5.0SMDJ28A	TP5.0SMDJ28CA	28	31.1	34.4	1	45.4	110.13	2	5PFG	5BFG
TP5.0SMDJ30A	TP5.0SMDJ30CA	30	33.3	36.8	1	48.4	103.31	2	5PFK	5BFK
TP5.0SMDJ33A	TP5.0SMDJ33CA	33	36.7	40.6	1	53.3	93.81	2	5PFM	5BFM
TP5.0SMDJ36A	TP5.0SMDJ36CA	36	40	44.2	1	58.1	86.06	2	5PFP	5BFP
TP5.0SMDJ40A	TP5.0SMDJ40CA	40	44.4	49.1	1	64.5	77.52	2	5PFR	5BFR
TP5.0SMDJ43A	TP5.0SMDJ43CA	43	47.8	52.8	1	69.4	72.05	2	5PFT	5BFT
TP5.0SMDJ45A	TP5.0SMDJ45CA	45	50	55.3	1	72.7	68.78	2	5PFV	5BFV
TP5.0SMDJ48A	TP5.0SMDJ48CA	48	53.3	58.9	1	77.4	64.60	2	5PFX	5BFX
TP5.0SMDJ51A	TP5.0SMDJ51CA	51	56.7	62.7	1	82.4	60.68	2	5PFZ	5BFZ
TP5.0SMDJ54A	TP5.0SMDJ54CA	54	60	66.3	1	87.1	57.41	2	5PGE	5BGE
TP5.0SMDJ58A	TP5.0SMDJ58CA	58	64.4	71.2	1	93.6	53.42	2	5PGG	5BGG

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#### ■ Rate and Characteristic Curve (T<sub>A</sub>=25°C unless otherwise noted)

Fig.1 - Peak Pulse Power Rating Curve

Fig.3 - Pulse Waveform

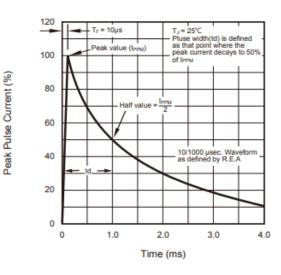


Fig.5 - Steady State Power Derating Curve 7.0 Steady State Power Dissipation (W) 6.0 5.0 4.0 3.0 2.0 1.0 0 0 25 50 75 100 125 150 175 Lead Temperature (°C)

Fig.2 - Pulse Derating Curve

100
80
80
80
40
40
0
25 50 75 100 125 150 175 200

Initial Junction Temperature (°C)

Fig.4 - Typical Junction Capacitance

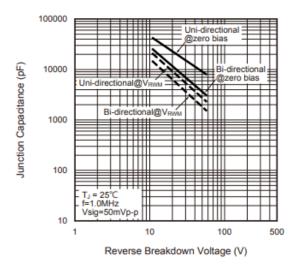
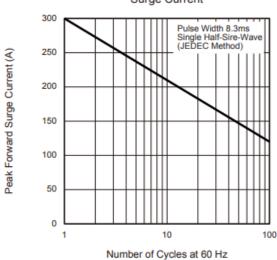


Fig.6 - Maximum Non-Repetitive Surge Current

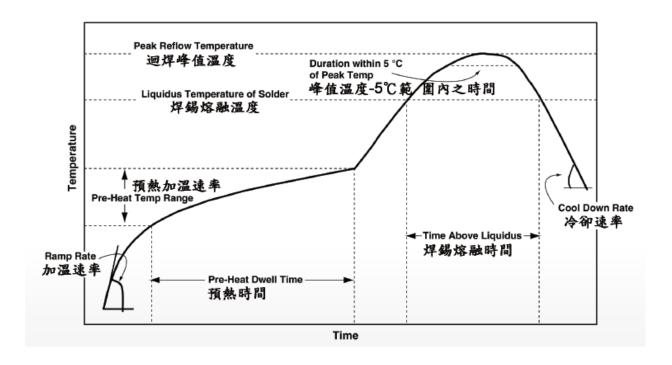




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#### IR-reflow soldering profile



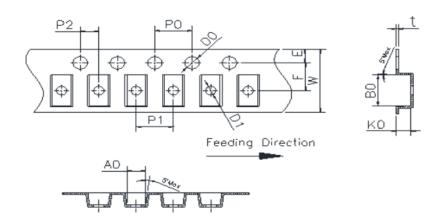
LEAD(Pb)-FREE SOLDER(SnAgCu) REFLOW PROFILE ATTRIBUTES				
PROFILE ATTRIBUTE	PROFILE ATTRIBUTE			
Peak Reflow Temperature	260(+8/-8)°C			
Time within 5°C of Peak Temperature	30s max			
Liquidus Temperature of Solder	217℃			
Cool Down Rate	6 °C/s max			
Time above Liquidus	60s to 150s			
Pre-heat Temperature Range	150°C to 200°C			
Pre-heat Dwell Time	60s to 120s			
Maximum Ramp Rate	3 °C/s max			

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#### ■ Packaging



		DO-214AB		
Item	Symbol	(SMC)		
		Unit:mm		
Carrier width	A0	6.05±0.1		
Carrier length	В0	8.31±0.1		
Carrier depth	K0	2.54±0.1		
Sprocket hole	D0/D1	1.55±0.05		
Sprocket hole position	E	1.75±0.1		
Punch hole position	F	7.5±0.1		
Sprocket hole pitch	P0	4±0.1		
Carrier pitch	P1	8±0.1		
Embossment center	P2	2±0.1		
Tape thickness	t	0.3±0.02		
Tape width	W	16±0.3		

#### **■** Quantity

Package Type	Reel Size (inch)	Quantity (pcs/reel)
DO-214AB	13	3,000

### ■ Warehouse Storage Conditions of product

• Storage Condition:

1. Storage Temperature: ≤25°C

2. Relative Humidity: 50%~80%RH

3. Keep away from corrosive atmosphere and sunlight.

• Period of Storage: 1 year.